Drawing No.: RGC-K-HTS-0003 /2

Date: 2024. 12. 24

Data sheet

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE &

PRECISION

Style: RGC1/20,1/16S,1/16,1/10,1/8

AEC-Q200 qualified

RoHS COMPLIANCE ITEM Halogen and Antimony Free

Note: •Stock conditions

Temperature: $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity: $25\% \sim 75\%$

The period of guarantee: Within 2 year from shipment by the company.

Solderability shall be satisfied.

•Product specification contained in this data sheet are subject to change at any time without notice.

•If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

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1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & precision, style of RGC1/20,1/16S,1/16,1/10,1/8.

1.2 Applicable documents

JIS C 5201-1: 2011, IEC60115-1: 2008, AEC-Q200 Rev.D

2. Classification

Type designation shall be the following form.

(Example)

RGC	1/8	С	123	D	TP
1	2	3	4	5	6
Sty	le				

1 Fixed thick film chip resistors; rectangular type & precision

- Style

2 Rated dissipation and / or dimension

3 Temperature coefficient of resistance

K	±100×10 ⁶ / °C
С	±50×10 ⁶ / °C

4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ

5 Tolerance on rated resistance

В	±0.1%
D	±0.5%
F	±1%

6 Packaging form

J	
PA	Press pocket taping
TH	Departaning
TP	Paper taping

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3. Rating

3.1 The ratings shall be in accordance with Table–1.

Table-1

Style	Rated	Temperatur	e coefficient of	Rated resistance	Preferred number	Tolerance on rated
Style	dissipation (W)	resistano	e (10⁴ / °C)	$range(\Omega)$	series for resistors	resistance
DCC1/20	0.05	С	± 50	1k~1M	E34.06	B(±0.1%),
RGC1/20	0.05	K	±100	51~976	E24,96	D(±0.5%)
		С	± 50	100~1M		B(±0.1%),
RGC1/16S	0.063	K	±100	1.02M~3.3M	E24,96	D(±0.5%)
		K	±100	10~97.6		F(±1%)
		С	± 50	100~1M		B(±0.1%),
RGC1/16	0.1			1.02M~3.3M	E24,96	D(±0.5%)
KGC 1/10	0.1	K	±100	10~97.6	⊏24,90	F(±1%)
				3.3~9.76		D(±0.5%)F(±1%)
						B(±0.1%),
RGC1/10	0.125	С	± 50	10~3.3M	E24,96	D(±0.5%)
1.601/10	0.123	C	± 50		L24,30	F(±1%)
				3.3~9.76		D(±0.5%)F(±1%)
						B(±0.1%),
RGC1/8	0.25	С	± 50	10~4.7M	E24,96	D(±0.5%)
1.001/0	0.20	9	_ 500		L2-1,50	F(±1%)
				3.3~9.76		F(±1%)

Style	Limiting element voltage (V)	Insulation voltage (V)	Category temperature range(°C)
RGC1/20	25	50	5 \ /
RGC1/16S	50	100	
RGC1/16	50	100	<i>–</i> 55∼+155
RGC1/10	150	500	
RGC1/8	200	300	

3.2 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

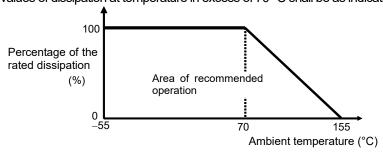


Figure-1 Derating curve

3.3 Rated voltage

d.c.or a.c.r.m.s.voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance
$$(\Omega)$$

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

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4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	Packaging form		Standard packaging quantity / units	Application
PA	Press pocket taping (paper taping)	8mm width, 2mm pitches	15,000 pcs.	RGC1/20
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RGC1/16S
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RGC1/16, 1/10, 1/8

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

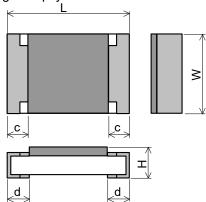


Figure-2

Table–3 Unit: mm

Style	L	W	Н	С	d
RGC1/20	0.6±0.03	0.3±0.03	0.23±0.03	0.1±0.05	0.15±0.05
RGC1/16S	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.1	$0.25^{+0.05}_{-0.10}$
RGC1/16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.25±0.10	0.3±0.1
RGC1/10	2.0±0.1	1.25±0.10	0.6±0.1	0.4±0.2	0.4±0.2
RGC1/8	3.1±0.1	1.6±0.15	0.6±0.1	0.5±0.25	0.5±0.25

5.2 Net weight (Reference)

0	,
Style	Net weight(mg)
RGC1/20	0.16
RGC1/16S	0.6
RGC1/16	2
RGC1/10	5
RGC1/8	9



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6. Marking

The Rated resistance shall be marked in 3 digits (E24) or 4 digits (E96) and marked on over coat side.

• E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

The Rated resistance of RGC1/16 should not be marked in 4 digits.

The Rated resistance of RGC1/20,1/16S should not be marked.

Marking example	Contents	Application
123	12×10 ³ $[\Omega] \rightarrow$ 12 $[k\Omega]$	RGC1/16,1/10,1/8
3R3	3.3 [Ω]	Less than 10Ω of RGC1/16,1/10,1/8
5623	$562\times10^{3} [\Omega] \rightarrow 562[k\Omega]$	RGC1/10,1/8
12R7	12.7 [Ω]	RGC1/10,1/8

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7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 2011.

7.2 The performance shall be satisfied in Table-4.

Table-4(1)

No.	Test items	Condition of test	Performance requirements
1	High temperature exposure	MIL-STD-202 Method 108	RGC1/20: Δ R/R: Within \pm (3%+0.1 Ω)
'	AEC Q200 - No.3	Ambient temperature:155±2°C,	Others: $\Delta R/R$: Within $\pm (3\%+0.152)$
	7120 0200 140.0	Condition: Without load,	No visible damage
		Duration: 1000 +48 h	NO VISIDIE dai Nage
		Interval measurements: 250 h and 500 h	
2	Temperature cycling	JESD22 Method JA-104	RGC1/20: ΔR/R: Within ±(3%+0.1Ω)
~	AEC Q200 - No.4	Temperature: -55±3°C / 125±2°C,	Others: $\Delta R/R$: Within $\pm (1\%+0.05\Omega)$
	7.20 0.200 1.011	Dwell time: 30min maximum at each temp.	No visible damage
		Transition time: 1 min. max.	The visible damage
		Number of cycles: 1000 cycles.	
		Interval measurements: 250 cy and 500 cy	
3	Bias humidity	MIL-STD-202 Method 103	RGC1/20: Δ R/R: Within \pm (3%+0.1 Ω)
	AEC Q200 - No.7	Condition: 85°C & 85% R.H.	Others: $\Delta R/R$: Within $\pm (2\% + 0.1\Omega)$
		Test power: 10% of rated power shall be	No visible damage
		applied for continuously.	
		Duration: 1,000 +48 h	
		Interval measurements: 250 h and 500 h	
4	Operational life	MIL-STD-202 Method 108	RGC1/20: Δ R/R: Within \pm (3%+0.1 Ω)
	AEC Q200 – No.8	Ambient temperature: 125±2°C	Others: Δ R/R: Within \pm (2%+0.1 Ω)
		The applied voltage shall be the voltage to be	No visible damage
		calculated at 35% of rated dissipation or the	
		limiting element voltage whichever is the	
		smaller.	
		Condition: The voltage shall be applied for	
		continuously.	
		Duration: 1000 +48 h	
		Interval measurements: 250 h and 500 h	
5	External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking
	AEC Q200 – No.9		and workmanship.
	<u>.</u>	15000014 tt 1 10 100	
6	Dimensions	JESD22 Method JB-100	As in Table–3
-	AEC Q200 – No.10	MIL CTD 202 Mathed 245	AD/D M/H : 1/40/ 2.250
7	Resistance to Solvents	MIL-STD-202 Method 215	Δ R/R: Within ±(1%+0.05 Ω)
	AEC Q200 – No.12	Solvent: 2-propanol at 25°C	No visible damage
		Immersion time: 3 min	
		Brush: 10 times brushing	
8	Mechanical Shock	Immersion and brush cycle: 3cycle MIL-STD-202 Method 213	AD/D: Within 1/0 50/ : 0.050\
°	AEC Q200 – No.13	Waveform: half sine,	Δ R/R: Within \pm (0.5%+0.05 Ω) No visible damage
		Peak value 100G,	TNO VISIDIE GAITIAGE
		Normal duration 6ms	
		Condition: XX'YY'ZZ', 18times total	
		Jonahon. 70 CT 1 ZZ, Tournoo total	

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Table-4(2)

No	Test items	Condition of test	Performance requirements
9	Vibration	MIL-STD-202 Method 204	Δ R/R: Within \pm (0.5%+0.05 Ω)
	AEC Q200 – No.14	Peak acceleration and Sweep time: 5 g's for 20	No visible damage
	7.20 0.200 1.0111	min , Frequency 10Hz to 2000Hz,	The visible damage
		Condition: 12 cycles each of 3 orientations	
10	Resistance to soldering heat	MIL-STD-202 Method 210	Δ R/R: Within \pm (0.5%+0.05 Ω)
	AEC Q200 - No.15	Solder bath temp: 260±5°C	No visible damage
		Immersed time: 10±1s	3
11	ESD test	AEC-Q200-002	Δ R/R: Within \pm (1%+0.1 Ω)
	AEC Q200 - No.17	Human body model, 2 Kohm, 150 pF,	No visible damage
		Test voltage: RGC1/16,1/10,1/8 800V	
		RGC1/20,1/16S 300V	
12	Solderability	J-STD-002	The surface of terminal immersed
	AEC Q200 – No.18	a) Bake the sample for 155 °C dwell time 4h /	shall be min. of 95% covered with a
		solder dipping 235°C/ 5s.	new coating of solder.
		Solder: Sn96.5-Ag3-Cu0.5	
		b) Category 3, Solder dipping 215°C/ 5s.	
		Solder: Sn63Pb37	
		c) Category 3, Solder dipping 260°C/ 30s.	
13	Electrical Characterization	1. D.C. Resistance	1. The resistance value shall
	AEC Q200 - No.19	2. Temperature Coefficient of Resistance	correspond with the rated
		+20 °C / +155°C	resistance taking into account the
			specified tolerance.
		111.04	2. As in Table–1
14	Flammability	UL-94	V-0 or V-1 are acceptable
4.5	AEC Q200 – No.20	450 0000 005	
15	Bending strength	AEC-Q200-005	Δ R/R: Within \pm (0.5%+0.05 Ω)
	AEC Q200 – No.21	Bending value2mm	No visible damage
40	A II	Holding time: 60sec.	15/5 14/4 1 (0.50/ 0.050)
16	Adhesion	AEC-Q200-006	Δ R/R: Within ±(0.5%+0.05 Ω)
	AEC Q200 – No.22	Pressurizing force:	No visible damage
		RGC1/10,1/8 17.7N	
		RGC1/16S,1/16 10N RGC1/20: 3N	
17	Flame retardance	Test time: 60±1s. AEC-Q200-001	The following FAILURE CRITERIA
''	AEC Q200 – No.24	Test conditions: 9VDC to 32VDC Each 1h	does not occur.
	ALO Q200 - NO.24	This test applies to rated voltages of 32V and	FAILURE CRITERIA
		above.	- Electrically open
		above.	a) A flame over 3.0 seconds duration
			b) An explosion
			c) A temperature above 350°C
			sustained for over 10 s
			343KII IGU IOI OVGI 103

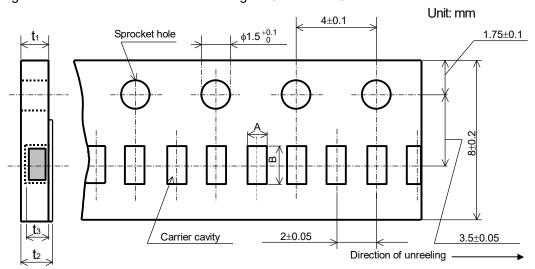
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8. Taping

- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



Figure–3									
	Unit: mm								
Style	Α	В	t 1	t ₂	t ₃				
RGC1/20	0.37±0.05	0.67±0.05	0.42±0.03	0.45±0.05	0.27±0.02				

8.2.2 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-4 and Table-6.

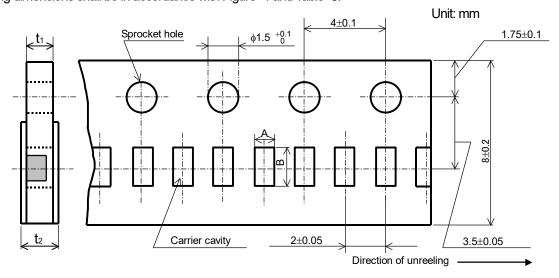


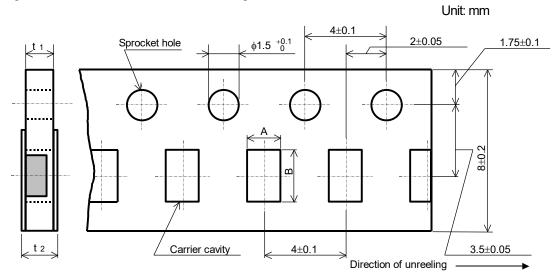
Figure-4 Table-6 Unit: mm Α В **t** 1 Style **RGC1/16S** $0.65^{+0.05}_{-0.10}$ $1.15^{+0.05}_{-0.10}$ 0.4 ± 0.05 0.5max.

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8.2.3 Paper taping (8mm width, 4mm pitches)

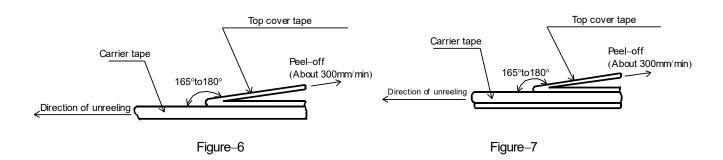
Taping dimensions shall be in accordance with Figure-5 and Table-7.



Figure_5

	Unit: mm				
	Style	Α	В	t 1	t 2
П	RGC1/16	1.15 ± 0.15	1.9 ± 0.2	0.6 ± 0.1	0.8max.
	RGC1/10	1.65 ± 0.15	2.5 ± 0.2	0.8 ± 0.1	1.0max.
	RGC1/8	2.00 ± 0.15	3.6 ± 0.2		

- 1). The cover tapes shall not cover the sprocket holes.
- Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RGC1/20: Figure-6, RGC1/16S, 1/16, 1/10, 1/8: Figure-7.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing. The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

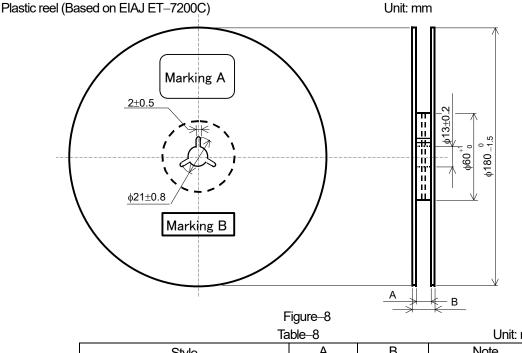


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8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-8 and Table-8.



Unit: mm В Note Α Style 11.4±1.0 Injection molding 9 +1.0 RGC1/20,1/16S,1/16,1/10,1/8 13±1.0 Vacuum forming

Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

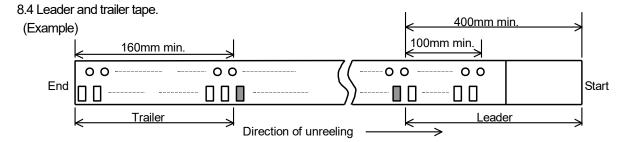


Figure-9

9. Marking on package

The label of a minimum package shall be legibly marked with follows.

9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

- (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark
- 9.2 Marking B (KAMAYA control label)